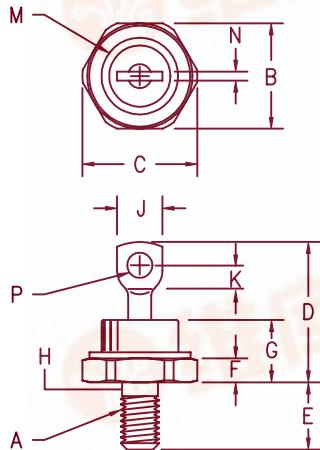


# Silicon Power Rectifier S/R307 Series



Dim.	Inches		Millimeter		Notes
	Minimum	Maximum	Minimum	Maximum	
A	---	---	---	---	1
B	.667	.687	16.95	17.44	
C	---	.793	---	20.14	
D	---	1.00	---	25.40	
E	.422	.453	10.72	11.50	
F	.115	.200	2.93	5.08	
G	---	.450	---	11.43	
H	.220	.249	5.59	6.32	2
J	.250	.375	6.35	9.52	
K	.156	---	3.97	---	
M	---	.667	---	16.94	Dia
N	---	.080	---	2.03	
P	.140	.175	3.56	4.44	Dia

D0203AB (D05)

Microsemi Catalog Number	Standard Reverse Voltage	Peak Reverse Voltage
S30720	R30720	200V
S30740	R30740	400V
S30760	R30760	600V

- Glass Passivated Die
- 1500 Amps Surge Rating
- Glass to metal seal construction
- VRM to 600V

## Electrical Characteristics

Average forward current	I <sub>F(AV)</sub> 85 Amps	T <sub>C</sub> = 136°C, Half Sine Wave, R <sub>θJC</sub> = 0.8°C/W
Maximum surge current	I <sub>FSM</sub> 1500 Amps	8.3ms, half sine, T <sub>J</sub> = 200°C
Max I <sup>2</sup> t for fusing	I <sup>2</sup> t 9300 A <sup>2</sup> s	
Max peak forward voltage	V <sub>FM</sub> 1.1 Volts	I <sub>FM</sub> = 200A; T <sub>J</sub> = 25°C*
Max peak reverse current	I <sub>RM</sub> 25 μA	V <sub>RRM, T<sub>J</sub></sub> = 25°C
Max peak reverse current	I <sub>RM</sub> 4.0 mA	V <sub>RRM, T<sub>J</sub></sub> = 150°C
Max Recommended Operating Frequency	10kHz	

\*Pulse test: Pulse width 300 μsec. Duty cycle 2%

## Thermal and Mechanical Characteristics

Storage temperature range	T <sub>STG</sub>	-65°C to 200°C
Operating junction temp range	T <sub>J</sub>	-65°C to 200°C
Maximum thermal resistance	R <sub>θJC</sub>	0.8°C/W Junction to Case
Mounting torque		25–30 inch pounds
Weight		.6 ounces (17 grams) typical

# S/R 307

Figure 1  
Typical Forward Characteristics

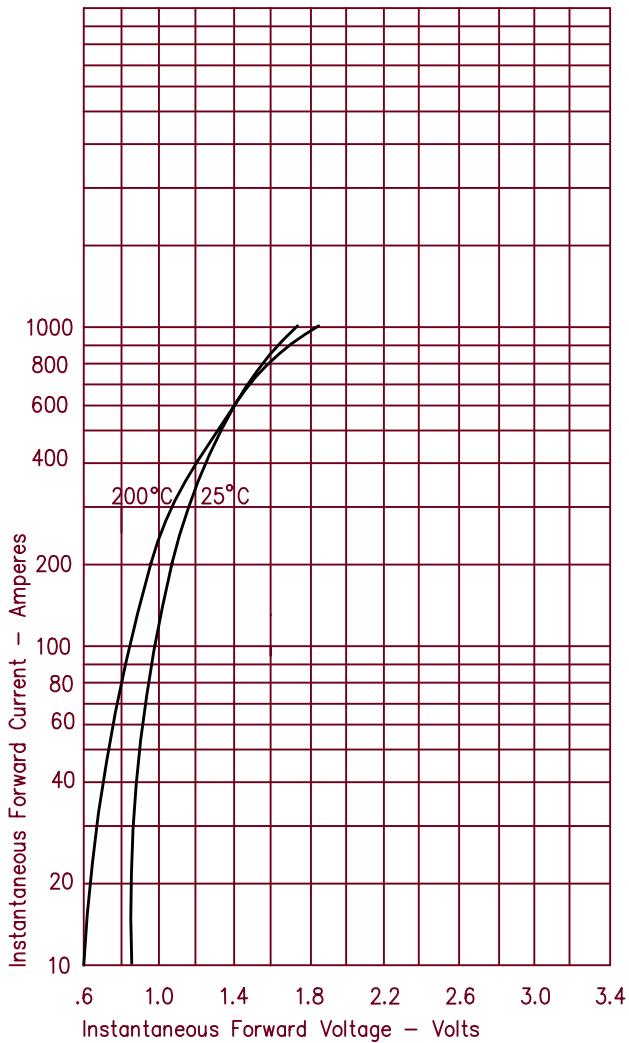


Figure 2  
Typical Reverse Characteristics

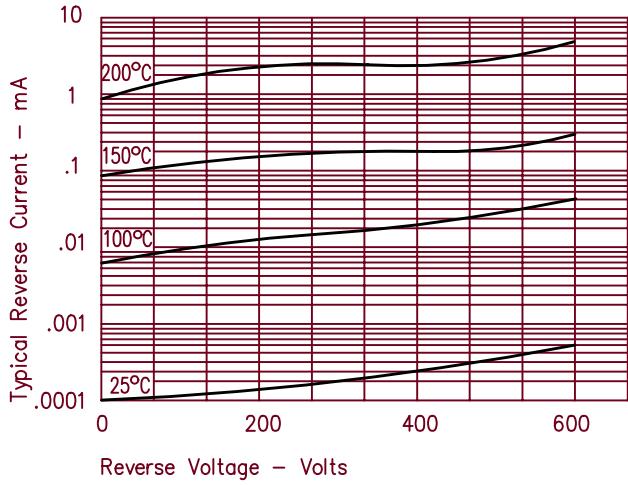


Figure 3  
Forward Current Derating

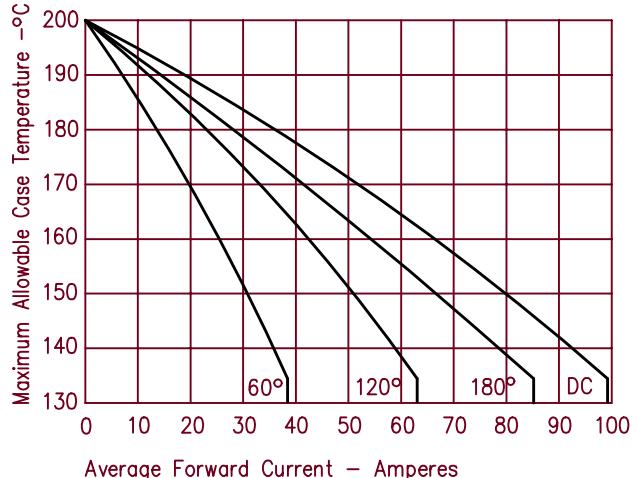


Figure 4  
Maximum Forward Power Dissipation

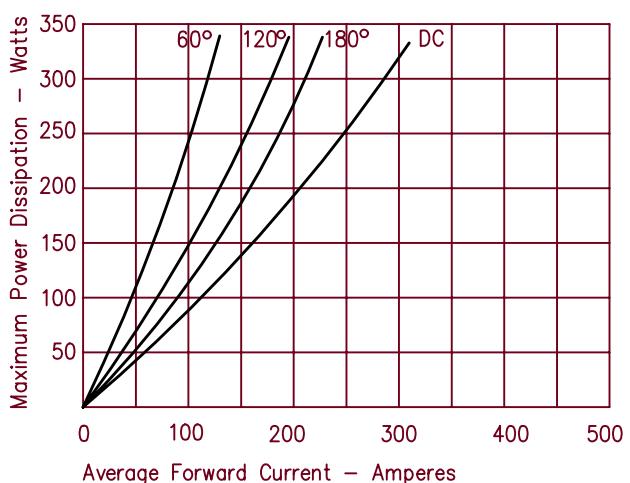


Figure 5  
Transient Thermal Impedance

